

74LVT126

3.3 V quad buffer; 3-state

Rev. 04 — 11 February 2005

Product data sheet

1. General description

The LVT126 is a high-performance BiCMOS product designed for V_{CC} operation at 3.3 V.

This device combines low static and dynamic power dissipation with high speed and high output drive. The 74LVT126 device is a quad buffer that is ideal for driving bus lines. The device features four output enable inputs (1OE, 2OE, 3OE and 4OE), each controlling one of the 3-state outputs.

2. Features

- Quad bus interface
- 3-state buffers
- Output capability: +64 mA and -32 mA
- TTL input and output switching levels
- Input and output interface capability to systems at 5 V supply
- Bus-hold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion and extraction permitted
- No bus current loading when output is tied to 5 V bus
- Power-up 3-state
- Latch-up protection:
 - ◆ JESD78: exceeds 500 mA
- ESD protection:
 - ◆ MIL STD 883 method 3015: exceeds 2000 V
 - ◆ Machine model: exceeds 200 V

3. Quick reference data

Table 1: Quick reference data

$GND = 0 V$; $T_{amb} = 25^{\circ}C$.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-----------|----------------------------|---|-----|------|-----|------|
| t_{PLH} | propagation delay nA to nY | $C_L = 50 \text{ pF}$; $V_{CC} = 3.3 \text{ V}$ | - | 2.3 | - | ns |
| t_{PHL} | propagation delay nA to nY | $C_L = 50 \text{ pF}$; $V_{CC} = 3.3 \text{ V}$ | - | 2.4 | - | ns |
| C_I | input capacitance | $V_I = 0 \text{ V}$ or V_{CC} | - | 4 | - | pF |
| C_O | output capacitance | outputs disabled; $V_O = 0 \text{ V}$ or 3.0 V | - | 8 | - | pF |
| I_{CC} | quiescent supply current | outputs disabled; $V_{CC} = 3.6 \text{ V}$ | - | 0.13 | - | mA |

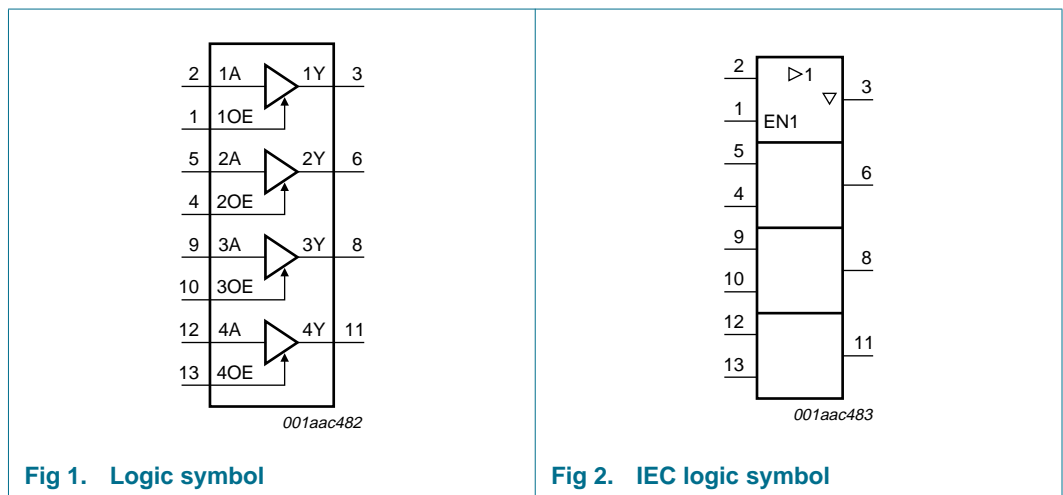
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4. Ordering information

Table 2: Ordering information

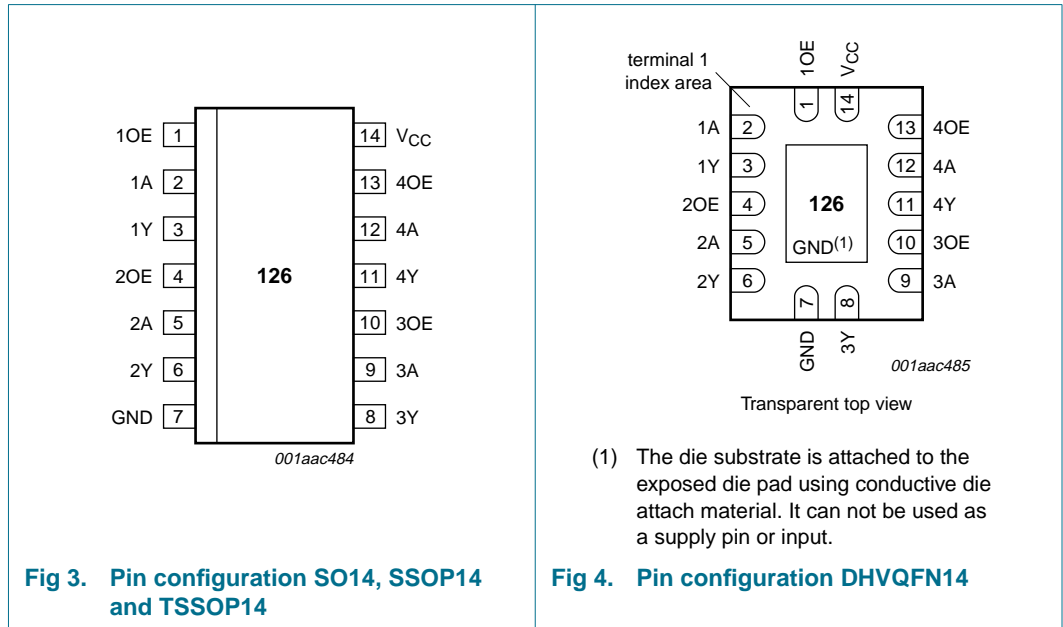
| Type number | Package | | | Version |
|-------------|-------------------|----------|--|----------|
| | Temperature range | Name | Description | |
| 74LVT126D | -40 °C to +85 °C | SO14 | plastic small outline package; 14 leads; body width 3.9 mm | SOT108-1 |
| 74LVT126DB | -40 °C to +85 °C | SSOP14 | plastic shrink small outline package; 14 leads; body width 5.3 mm | SOT337-1 |
| 74LVT126PW | -40 °C to +85 °C | TSSOP14 | plastic thin shrink small outline package; 14 leads; body width 4.4 mm | SOT402-1 |
| 74LVT126BQ | -40 °C to +85 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm | SOT762-1 |

5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3: Pin description

| Symbol | Pin | Description |
|-----------------|-----|-----------------------|
| 1OE | 1 | 1 output enable input |
| 1A | 2 | 1 data input |
| 1Y | 3 | 1 data output |
| 2OE | 4 | 2 output enable input |
| 2A | 5 | 2 data input |
| 2Y | 6 | 2 data output |
| GND | 7 | ground (0 V) |
| 3Y | 8 | 3 data output |
| 3A | 9 | 3 data input |
| 3OE | 10 | 3 output enable input |
| 4Y | 11 | 4 data output |
| 4A | 12 | 4 data input |
| 4OE | 13 | 4 output enable input |
| V _{CC} | 14 | supply voltage |

7. Functional description

7.1 Function table

Table 4: Function table ^[1]

| Input | | Output |
|-------|----|--------|
| nOE | nA | nY |
| H | L | L |
| H | H | H |
| L | X | Z |

- [1] H = HIGH voltage level;
 L = LOW voltage level;
 X = don't care;
 Z = high-impedance OFF-state.

8. Limiting values

Table 5: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|----------------------|-----------------------------------|---------------------|------|------|
| V_{CC} | supply voltage | | -0.5 | +4.6 | V |
| V_I | input voltage | | ^[1] -0.5 | +7.0 | V |
| V_O | output voltage | output in OFF-state or HIGH-state | ^[1] -0.5 | +7.0 | V |
| I_{IK} | input diode current | $V_I < 0$ V | - | -50 | mA |
| I_{OK} | output diode current | $V_O < 0$ V | - | -50 | mA |
| I_O | output current | output in LOW-state | - | 128 | mA |
| | | output in HIGH-state | - | -64 | mA |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| T_j | junction temperature | | ^[2] - | 150 | °C |

- [1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.
- [2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

9. Recommended operating conditions

Table 6: Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------------|------------------------------------|---|-----|-----|-----|--------------------|
| V_{CC} | supply voltage | | 2.7 | - | 3.6 | V |
| V_I | input voltage | | 0 | - | 5.5 | V |
| V_{IH} | HIGH-level input voltage | | 2.0 | - | - | V |
| V_{IL} | LOW-level input voltage | | - | - | 0.8 | V |
| I_{OH} | HIGH-level output current | | - | - | -32 | mA |
| I_{OL} | LOW-level output current | none | - | - | 32 | mA |
| | | current duty cycle $\leq 50\%$; $f \geq 1$ kHz | - | - | 64 | mA |
| $\Delta t/\Delta V$ | input transition rise or fall rate | outputs enabled | - | - | 10 | ns/V |
| T_{amb} | ambient temperature | in free air | -40 | - | +85 | $^{\circ}\text{C}$ |

10. Static characteristics

Table 7: Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit | |
|---|---------------------------|---|--|----------------|-----------|---------------|---------------|
| $T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$ [1] | | | | | | | |
| V_{IK} | input diode voltage | $I_{IK} = -18\text{ mA}$; $V_{CC} = 2.7\text{ V}$ | - | -0.9 | -1.2 | V | |
| V_{OH} | HIGH-level output voltage | $I_{OH} = -100\text{ }\mu\text{A}$; $V_{CC} = 2.7\text{ V}$ to 3.6 V ; | $V_{CC} - 0.2$ | $V_{CC} - 0.1$ | - | V | |
| | | $I_{OH} = -8\text{ mA}$; $V_{CC} = 2.7\text{ V}$ | 2.4 | 2.5 | - | V | |
| | | $I_{OH} = -32\text{ mA}$; $V_{CC} = 3.0\text{ V}$ | 2.0 | 2.2 | - | V | |
| V_{OL} | LOW-level output voltage | $V_{CC} = 2.7\text{ V}$ | | | | | |
| | | $I_{OL} = 100\text{ }\mu\text{A}$ | - | 0.1 | 0.2 | V | |
| | | $I_{OL} = 24\text{ mA}$ | - | 0.3 | 0.5 | V | |
| | | $V_{CC} = 3.0\text{ V}$ | | | | | |
| | | $I_{OL} = 16\text{ mA}$ | - | 0.25 | 0.4 | V | |
| | | $I_{OL} = 32\text{ mA}$ | - | 0.3 | 0.5 | V | |
| I_{LI} | input leakage current | $I_{OL} = 64\text{ mA}$ | - | 0.4 | 0.55 | V | |
| | | all input pins | $V_{CC} = 0\text{ V}$ or 3.6 V ; $V_I = 5.5\text{ V}$ | - | 1 | 10 | μA |
| | | control pins | $V_{CC} = 3.6\text{ V}$; V_{CC} or GND | - | ± 0.1 | ± 1 | μA |
| | | data pins | $V_{CC} = 3.6\text{ V}$; $V_I = V_{CC}$ | [2] - | 0.1 | 1 | μA |
| | | $V_{CC} = 3.6\text{ V}$; $V_I = 0\text{ V}$ | [2] - | -1 | -5 | μA | |
| I_{OFF} | power-down output current | $V_{CC} = 0\text{ V}$; V_I or $V_O = 0\text{ V}$ to 4.5 V | - | 1 | ± 100 | μA | |
| I_{HOLD} | bus hold current A input | $V_{CC} = 3\text{ V}$; $V_I = 0.8\text{ V}$ | [3] 75 | 150 | - | μA | |
| | | $V_{CC} = 3\text{ V}$; $V_I = 2.0\text{ V}$ | -75 | -150 | - | μA | |
| | | $V_{CC} = 0\text{ V}$ to 3.6 V ; $V_I = 3.6\text{ V}$ | ± 500 | - | - | μA | |

Table 7: Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|------------------|---|---|-------|---------|-----------|---------|
| I_{EX} | external current into output | output in HIGH-state when $V_O > V_{CC}$; $V_O = 5.5$ V and $V_{CC} = 3.0$ V | - | 60 | 125 | μ A |
| I_{PU}, I_{PD} | power-up or power-down 3-state output current | $V_{CC} \leq 1.2$ V; $V_O = 0.5$ V to V_{CC} ; $V_I = GND$ or V_{CC} ; nOE = don't care | [4] - | ± 1 | ± 100 | μ A |
| I_{OZ} | 3-state output current | $V_{CC} = 3.6$ V | | | | |
| | | output HIGH: $V_O = 3.0$ V | - | 1 | 5 | μ A |
| | | output LOW: $V_O = 0.5$ V | - | -1 | -5 | μ A |
| I_{CC} | quiescent supply current | $V_{CC} = 3.6$ V; $V_I = GND$ or V_{CC} ; $I_O = 0$ A | | | | |
| | | outputs HIGH | - | 0.13 | 0.19 | mA |
| | | outputs LOW | - | 2 | 7 | mA |
| | | outputs disabled | [5] - | 0.13 | 0.19 | mA |
| ΔI_{CC} | additional supply current per input pin | $V_{CC} = 3$ V to 3.6 V; one input at $V_{CC} - 0.6$ V and other inputs at V_{CC} or GND | [6] - | 0.1 | 0.2 | mA |
| C_I | input capacitance | $V_I = 0$ V or V_{CC} | - | 4 | - | pF |
| C_O | output capacitance | outputs disabled; $V_O = 0$ V or 3.0 V | - | 8 | - | pF |

- [1] Typical values are measured at nominal V_{CC} and $T_{amb} = 25$ °C.
- [2] Unused pins at V_{CC} or GND.
- [3] This is the bus hold overdrive current required to force the input to the opposite logic state.
- [4] This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 ms. From $V_{CC} = 1.2$ V to $V_{CC} = 3.3$ V ± 0.3 V a transition time of 100 μ s is permitted. This parameter is valid for $T_{amb} = 25$ °C only.
- [5] Measured with outputs pulled up to V_{CC} or GND.
- [6] This is the increase in supply current for each input at the specified voltage level other than V_{CC} or GND.

11. Dynamic characteristics

Table 8: Dynamic characteristics

$GND = 0$ V; $t_r = t_f = 2.5$ ns; $C_L = 50$ pF; $R_L = 500$ Ω ; for test circuit see [Figure 7](#).

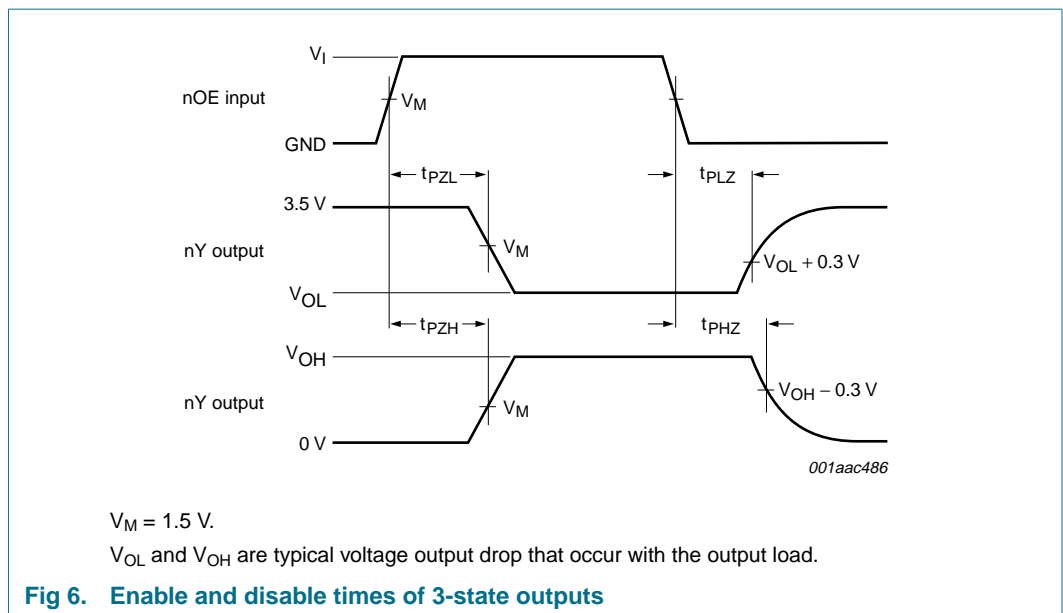
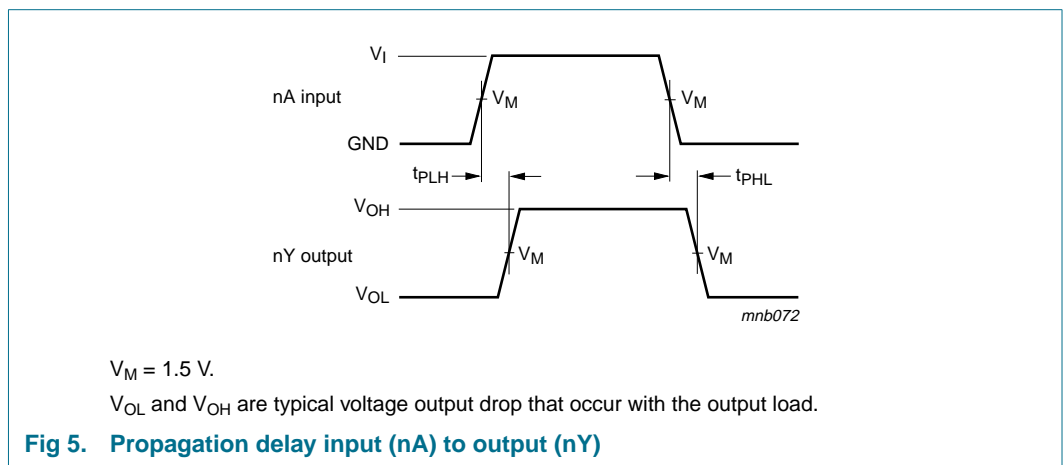
| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|------------------------------|------------------------------|-----|-----|-----|------|
| $T_{amb} = -40$ °C to $+85$ °C [1] | | | | | | |
| t_{PLH} | propagation delay nA to nY | $V_{CC} = 2.7$ V | - | - | 4.5 | ns |
| | | $V_{CC} = 3.3$ V ± 0.3 V | 1.0 | 2.3 | 3.8 | ns |
| t_{PHL} | propagation delay nA to nY | $V_{CC} = 2.7$ V | - | - | 4.4 | ns |
| | | $V_{CC} = 3.3$ V ± 0.3 V | 1.0 | 2.4 | 3.9 | ns |
| t_{PZH} | output enable time nOE to nY | $V_{CC} = 2.7$ V | - | - | 6.1 | ns |
| | | $V_{CC} = 3.3$ V ± 0.3 V | 1.0 | 3.6 | 5.4 | ns |
| t_{PZL} | output enable time nOE to nY | $V_{CC} = 2.7$ V | - | - | 5.8 | ns |
| | | $V_{CC} = 3.3$ V ± 0.3 V | 1.1 | 3.6 | 5.2 | ns |

Table 8: Dynamic characteristics ...continued
 $GND = 0\text{ V}$; $t_r = t_f = 2.5\text{ ns}$; $C_L = 50\text{ pF}$; $R_L = 500\ \Omega$; for test circuit see [Figure 7](#).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-----------|-------------------------------|--|-----|-----|-----|------|
| t_{PHZ} | output disable time nOE to nY | $V_{CC} = 2.7\text{ V}$ | - | - | 4.3 | ns |
| | | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1.0 | 2.2 | 3.8 | ns |
| t_{PLZ} | output disable time nOE to nY | $V_{CC} = 2.7\text{ V}$ | - | - | 6.1 | ns |
| | | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ | 1.3 | 3.6 | 5.5 | ns |

[1] Typical values are at $V_{CC} = 3.3\text{ V}$ and $T_{amb} = 25\text{ }^\circ\text{C}$.

12. Waveforms



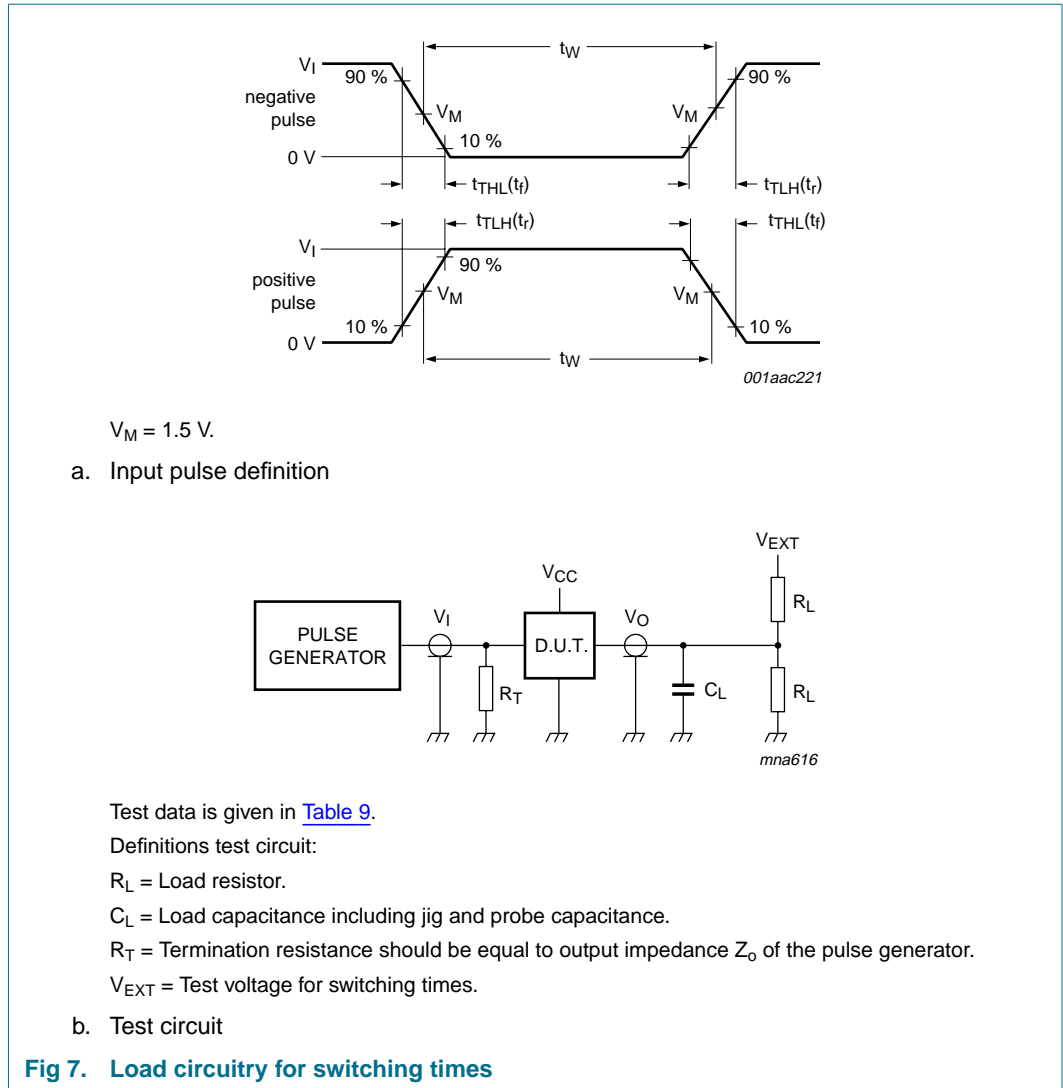


Table 9: Test data

| Input | | | | Load | | V_{EXT} | | |
|-------|-----------------------|--------|-----------------------|-------|--------------|--------------------|--------------------|--------------------|
| V_I | f_i | t_W | t_r, t_f | C_L | R_L | t_{PHZ}, t_{PZH} | t_{PLZ}, t_{PZL} | t_{PLH}, t_{PHL} |
| 2.7 V | $\leq 10 \text{ MHz}$ | 500 ns | $\leq 2.5 \text{ ns}$ | 50 pF | 500 Ω | GND | 6 V | open |

13. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



Fig 8. Package outline SO14 (SOT108-1)

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1

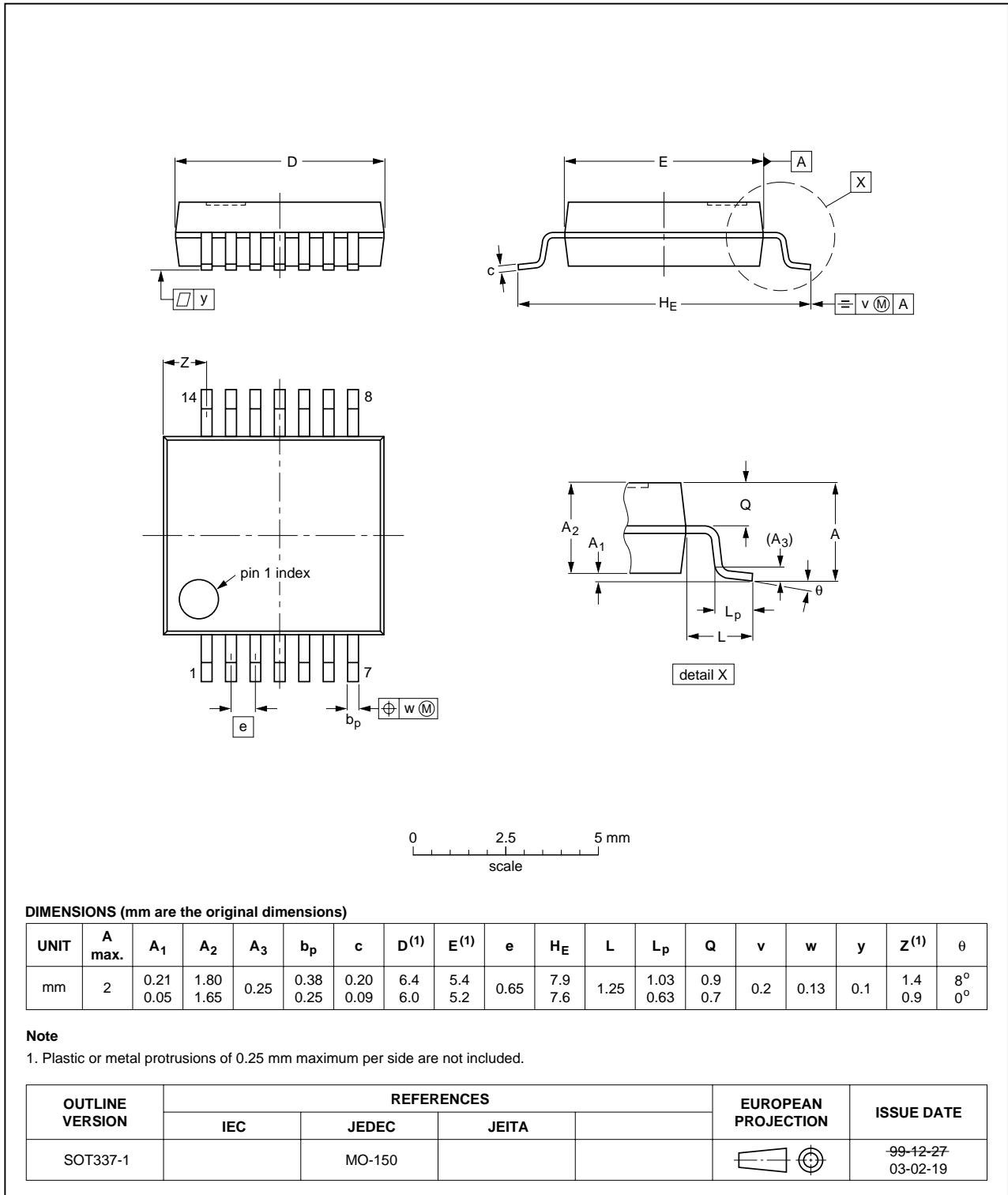


Fig 9. Package outline SSOP14 (SOT337-1)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

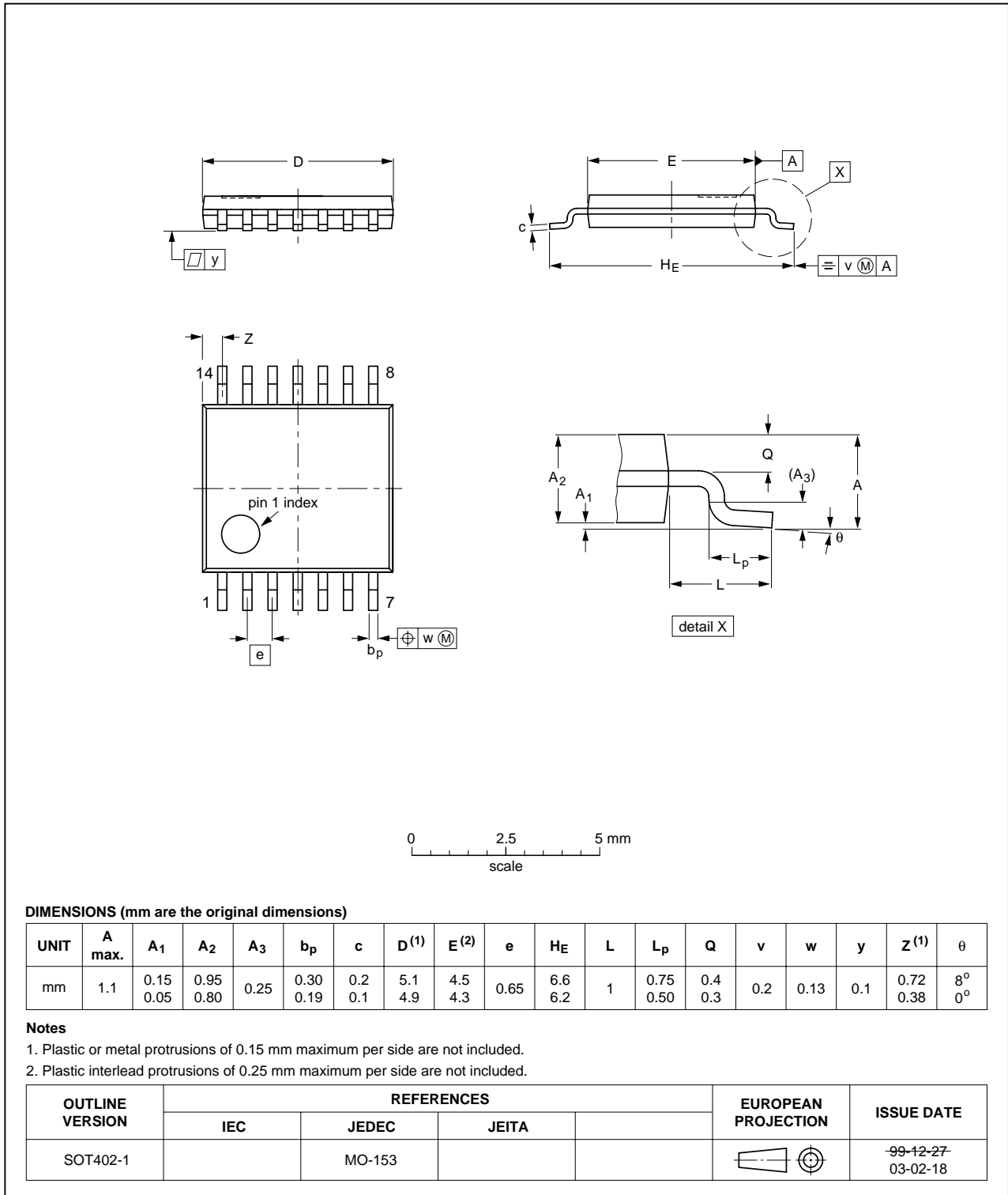


Fig 10. Package outline TSSOP14 (SOT402-1)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm

SOT762-1

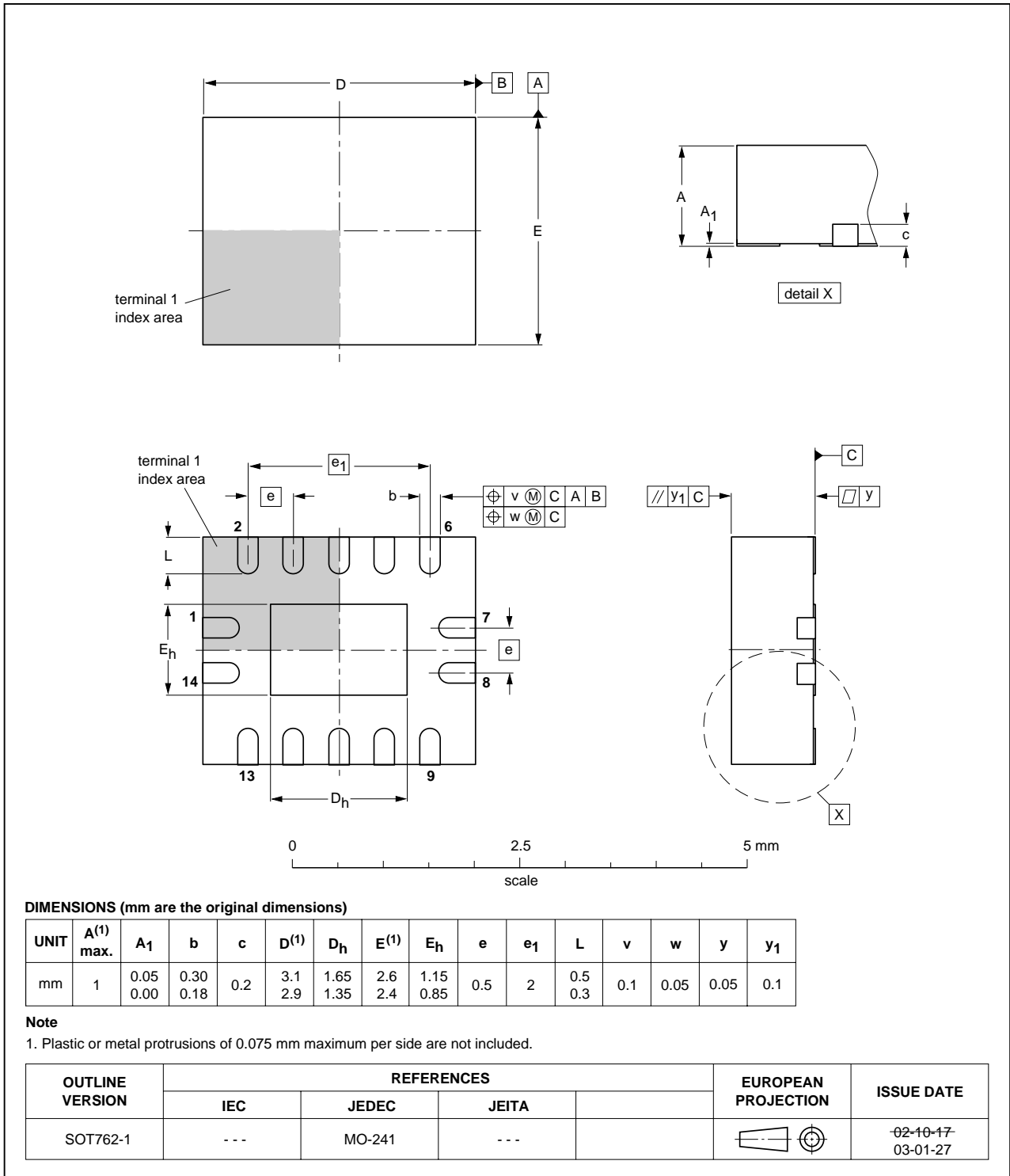


Fig 11. Package outline DHVQFN14 (SOT762-1)

14. Revision history

Table 10: Revision history

| Document ID | Release date | Data sheet status | Change notice | Doc. number | Supersedes |
|----------------|--|-----------------------|---------------|----------------|------------|
| 74LVT126_4 | 20050211 | Product data sheet | - | 9397 750 14553 | 74LVT126_3 |
| Modifications: | <ul style="list-style-type: none">The format of this data sheet has been redesigned to comply with the new presentation and information standard of Philips Semiconductors.Figure 4: added Figure note 1. | | | | |
| 74LVT126_3 | 20040624 | Product data sheet | - | 9397 750 13542 | 74LVT126_2 |
| 74LVT126_2 | 19980219 | Product specification | - | 9397 750 03515 | 74LVT126_1 |
| 74LVT126_1 | - | - | - | - | - |

15. Data sheet status

| Level | Data sheet status ^[1] | Product status ^[2] ^[3] | Definition |
|-------|----------------------------------|--|--|
| I | Objective data | Development | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice. |
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16. Definitions

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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